



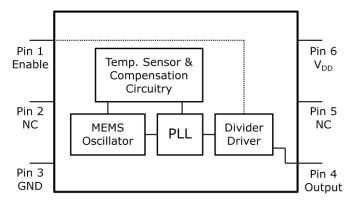
Programmable Low-Jitter Precision CMOS Oscillator

General Description

The DSC8101 & DSC8121 series of high performance field-programmable oscillators utilizes a proven silicon MEMS technology to provide excellent jitter and stability over a of range supply voltages temperatures. Using the TIMEFLASH programmer, the end user can easily program the oscillators' frequency in the field for immediate testing or use in advance prototype development or production.

DSC8101 has a standby feature allowing it to completely power-down when EN pin is pulled low; whereas for DSC8121, only the outputs are disabled when EN is low. Both oscillators are available in industry standard packages, including the small 3.2x2.5 mm², and are "drop-in" replacement for standard 4-pin CMOS quartz oscillators.

Block Diagram



Output Enable Modes

	EN Pin	DSC8101	DSC8121			
	High Output Active NC Output Active Low Standby		Output Active			
			Output Active			
			Output Disabled			

Features

- Low RMS Phase Jitter: <1 ps (typ)
- High Stability: ±10, ±25, ±50 ppm
- Wide Temperature Range
 - o Automotive: -55° to 125° C
 - o Ext. Industrial: -40° to 105° C
 - o Industrial: -40° to 85° C
 - o Ext. commercial: -20° to 70° C
- High Supply Noise Rejection: -50 dBc
- Wide Freq. Range: 10 to 170 MHz
- Small Industry Standard Footprints
 2.5x2.0, 3.2x2.5, 5.0x3.2, & 7.0x5.0 mm
- Excellent Shock & Vibration Immunity
 - Qualified to MIL-STD-883
- High Reliability
 - o 20x better MTF than quartz oscillators
- Low Current Consumption
- Supply Range of 2.25 to 3.6 V
- Standby & Output Enable Function
- Lead Free & RoHS Compliant

Applications

- Storage Area Networks
 - o SATA, SAS, Fibre Channel
- Passive Optical Networks
 - o EPON, 10G-EPON, GPON, 10G-PON
- Ethernet
 - 1G, 10GBASE-T/KR/LR/SR, and FCoE
- HD/SD/SDI Video & Surveillance
- PCI Express
- DisplayPort

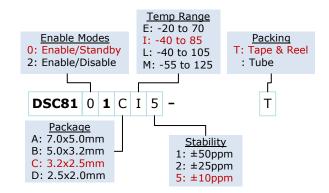


Absolute Maximum Ratings

Item	Min	Max	Unit	Condition
Supply Voltage	-0.3	+4.0	V	
Input Voltage	-0.3	$V_{DD} + 0.3$	V	
Junction Temp	-	+150	°C	
Storage Temp	-55	+150	°C	
Soldering Temp	-	+260	°C	40sec max.
ESD	-		V	
HBM		4000		
MM		400		
CDM		1500		

Note: 1000+ years of data retention on internal memory

Ordering Code



Specifications

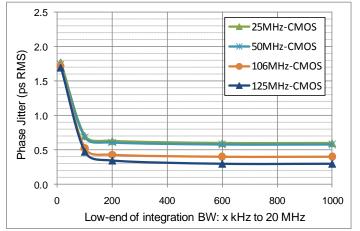
Parameter		Condition	Min.	Typ.	Max.	Unit
Supply Voltage ¹	V_{DD}		2.25		3.6	V
Supply Current	I_{DD}	EN pin low – output is disabled DSC8101 DSC8121		20	0.095 22	mA
Frequency Stability Ext Comm. & Ind. only All temp ranges All temp ranges	Δf	Includes frequency variations due to initial tolerance, temp. and power supply voltage			±10 ±25 ±50	ppm
Aging	Δf	1 year @25°C			±5	ppm
Startup Time ²	t_{SU}	T=25°C			5	ms
Input Logic Levels Input logic high Input logic low	$egin{array}{c} egin{array}{c} \egin{array}{c} \egin{array}{c} \egin{array}{c} \egin{array}{c} \egin{array}{c} \egin{array}$		0.75xV _{DD}		- 0.25xV _{DD}	V
Output Disable Time ³	t_{DA}				5	ns
Output Enable Time	t _{EN}	DSC8101 DSC8121			5 20	ms ns
Enable Pull-Up Resistor ⁴		Pull-up resistor exist		40		kΩ
		CMOS Output				
Supply Current ⁴	I_{DD}	output is enabled $C_L=15$ pF, $F_0=125$ MHz		31	35	mA
Output Logic Levels Output logic high Output logic low	$V_{ m OH}$	I=±6mA	0.9xV _{DD}		- 0.1xV _{DD}	V
Output Transition time ³ Rise Time Fall Time	t _R t _F	20% to 80% C _L =15pF		1.1 1.3	2 2	ns
Frequency	f_0	All temp range except Auto Auto temp range	10		170 100	MHz
Output Duty Cycle	SYM		45		55	%
Period Jitter	J_{PER}	Fout=125MHz		3		ps _{RMS}
Integrated Phase Noise	${\sf J}_{\sf PH}$	200kHz to 20MHz @ 125MHz 100kHz to 20MHz @ 125MHz 12kHz to 20MHz @ 125MHz		0.3 0.38 1.7	2	ps _{RMS}

- Pin 6 V_{DD} should be filtered with 0.1uf capacitor.
- v_{DD} since to 100PPM of output frequency after V_{DD} is applied and outputs are enabled. Output Waveform and Test Circuit figures below define the parameters.
- 2. 3.
- Output is enabled if pad is floated or not connected.

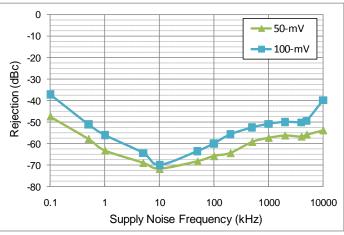
MK-Q-B-P-D-110410-01-2



Nominal Performance Parameters (Unless specified otherwise: $T=25^{\circ}$ C, $V_{DD}=3.3$ V)

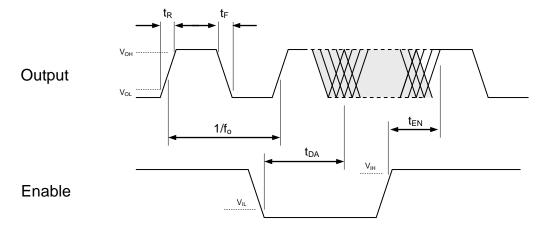


Phase jitter (integrated phase noise)

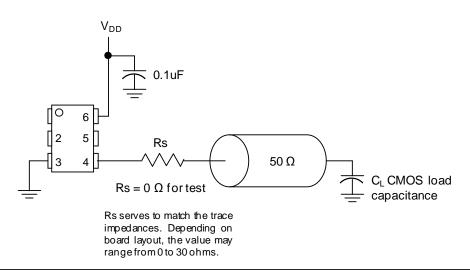


Power supply rejection ratio

Output Waveform

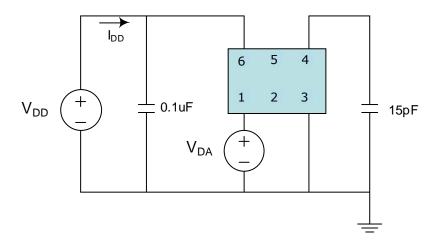


Typical Termination Scheme

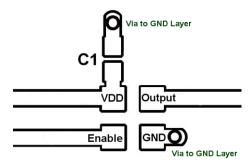




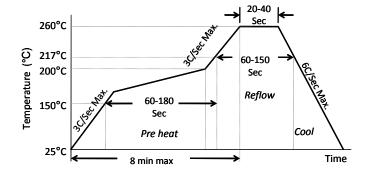
Test Circuit



Board Layout (recommended)



Solder Reflow Profile



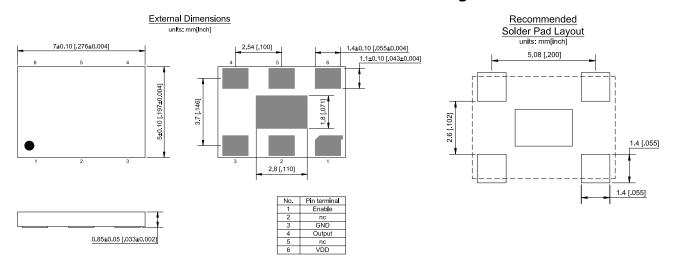
MSL 1 @ 260°C refer to JSTD-020C						
Ramp-Up Rate (200°C to Peak Temp)	3°C/Sec Max.					
Preheat Time 150°C to 200°C	60-180 Sec					
Time maintained above 217°C	60-150 Sec					
Peak Temperature	255-260°C					
Time within 5°C of actual Peak	20-40 Sec					
Ramp-Down Rate	6°C/Sec Max.					
Time 25°C to Peak Temperature	8 min Max.					

MK-Q-B-P-D-110410-01-2

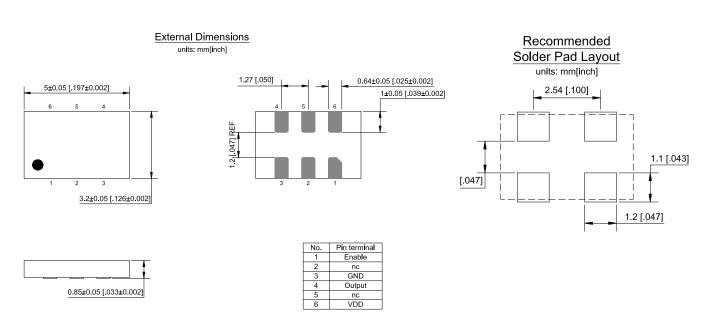


Package Dimensions

7.0 x 5.0 mm Plastic Package

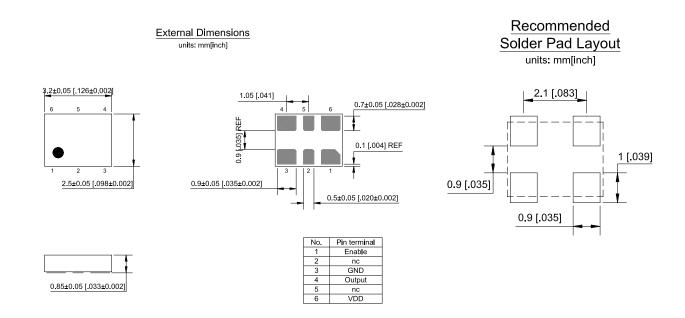


5.0 x 3.2 mm Plastic Package

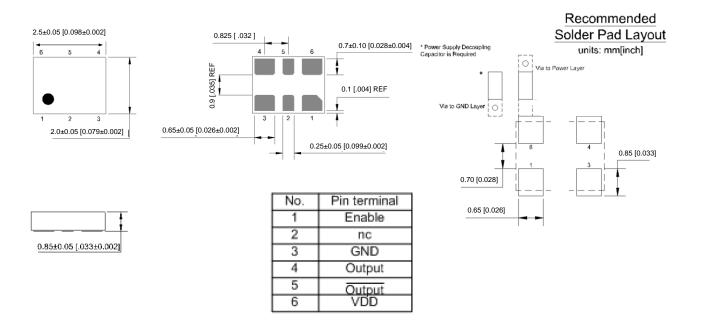




3.2 x 2.5 mm Plastic Package



2.5 x 2.0 mm Plastic Package



Disclaimer:

Micrel makes no representations or warranties with respect to the accuracy or completeness of the information furnished in this data sheet. This information is not intended as a warranty and Micrel does not assume responsibility for its use. Micrel reserves the right to change circuitry, specifications and descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Micrel's terms and conditions of sale for such products, Micrel assumes no liability whatsoever, and Micrel disclaims any express or implied warranty relating to the sale and/or use of Micrel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right.

MICREL, Inc. • 2180 Fortune Drive, San Jose, California 95131 • USA
Phone: +1 (408) 944-0800 • Fax: +1 (408) 474-1000 • Email: hbwhelp@micrel.com • <u>www.micrel.com</u>

MK-Q-B-P-D-110410-01-2